

2mm FLAT TOP LED LAMP

Part Number:

Features

- MOUNTS FLUSH WITH PANEL.
- LOW POWER CONSUMPTION.
- \bullet LONG LIFE SOLID STATE RELIABILITY.
- RoHS COMPLIANT.





Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25(0.01") unless otherwise noted.
- $3. {\rm Specifications}$ are subject to change without notice.

Absolute Maximum Ratings (TA=25°C)		UG (GaP)	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	140	mA	
Power Dissipation	Рт	62.5	mW	
Operating Temperature	TA	-40 ~ +85	0.0	
Storage Temperature	Tstg	-40 ~ +85	$^{\circ}\mathrm{C}$	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds			
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds			

5.0(.197) 27(1.063)MIN. 1.95(.077) 1.5(.06)TYP. CATHODE 0.75(.03) 1.0MAX. 0000 1.0MAX. 00000 1.0MAX. 0000 1.0MAX. 00000 1.0MAX	6.04(.1)
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Operating Characteristics (Ta=25°C)		UG (GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	$V_{\rm F}$	2.0	V
Forward Voltage (Max.) (IF=10mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=10mA)	λΡ	565	nm
Wavelength Of Dominant Emission (Typ.) (IF=10mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=10mA)	Δλ	30	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	15	pF

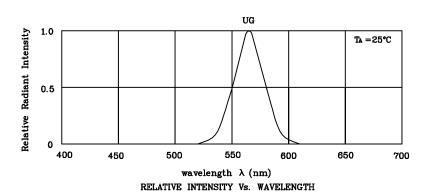
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=10mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XSUG29D	Green	GaP	Green Diffused	1.8	5	565	70°
Published Date : J	AN 16, 2008	Drawin	g No : XDSA2303	V4	Chec	eked : Shin Chi	P.1/4



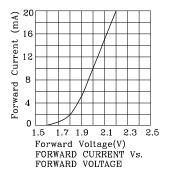
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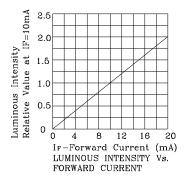
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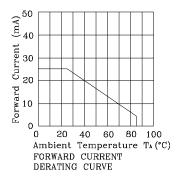


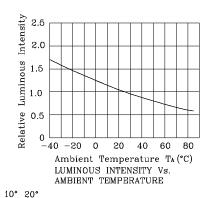


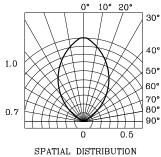
♦ UG











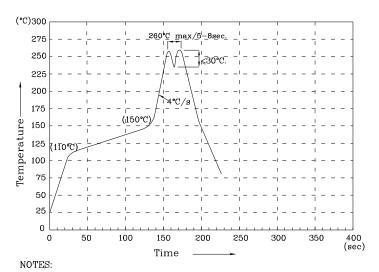
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Part Number: XSUG29D

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Wave Soldering Profile For Lead-free Through-hole LED.



- 1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree °C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4. No more than once.

Remarks:

 $If \ special \ sorting \ is \ required \ (e.g. \ binning \ based \ on \ forward \ voltage, \ luminous \ intensity, \ or \ wavelength),$

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: \pm -0.1V

Note: Accuracy may depend on the sorting parameters.

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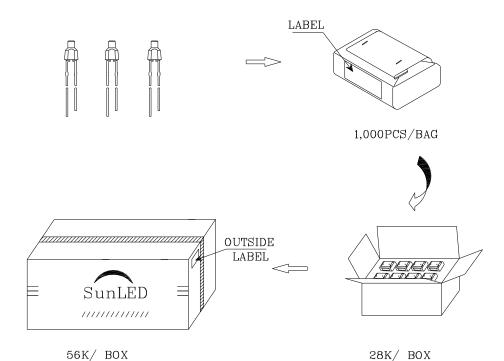


Part Number: XSUG29D

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PACKING & LABEL SPECIFICATIONS

XSUG29D





QTY: 1,000 pcs CODE: XXX

S/N : XX

LOT NO:



RoHS Compliant

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